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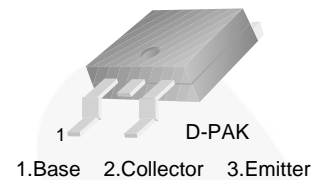
FAIRCHILD™

April 2015

MJD45H11
PNP Epitaxial Silicon Transistor

Features

- General-Purpose Power and Switching such as Output or Driver Stages in Applications
- D-PAK for Surface-Mount Applications
- Lead-Formed for Surface Mount Application (No Suffix)
- Fast Switching Speeds
- Low Collector Emitter Saturation Voltage

1   D-PAK

1.Base   2.Collector   3.Emitter

Ordering Information

Part Number	Top Mark	Package	Packing Method
MJD45H11TF	MJD45H11	TO-252 3L (DPAK)	Tape and Reel
MJD45H11TM	MJD45H11	TO-252 3L (DPAK)	Tape and Reel

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25°C$ unless otherwise noted.

Symbol	Parameter	Value	Unit
V_{CEO}	Collector-Emitter Voltage	- 80	V
V_{EBO}	Emitter-Base Voltage	- 5	V
I_C	Collector Current (DC)	- 8	A
I_{CP}	Collector Current (Pulse)	- 16	A
P_C	Collector Dissipation ($T_C = 25°C$)	20	W
	Collector Dissipation ($T_A = 25°C$)	1.75	
T_J	Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	- 55 to +150	°C

Electrical Characteristics

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_{CEO}(sus)	Collector-Emitter Sustaining Voltage[1]	I_C = - 30 mA, I_B = 0	- 80			V
I_{CEO}	Collector Cut-Off Current	V_{CE} = - 80 V, I_B = 0			- 10	μA
I_{EBO}	Emitter Cut-Off Current	V_{EB} = - 5 V, I_C = 0			- 50	μA
h_{FE}	DC Current Gain[1]	V_{CE} = - 1 V, I_C = - 2 A	60			
		V_{CE} = - 1 V, I_C = - 4 A	40			
V_{CE}(sat)	Collector-Emitter Saturation Voltage[1]	I_C = - 8 A, I_B = - 0.4 A			- 1	V
V_{BE}(sat)	Base-Emitter Saturation Voltage[1]	I_C = - 8 A, I_B = - 0.8 A			- 1.5	V
f_T	Current Gain Bandwidth Product	V_{CE} = - 10 V, I_C = - 0.5 A		40		MHz
C_{ob}	Collector Capacitance	V_{CB} = - 10 V, f = 1 MHz		230		pF
t_{ON}	Turn-On Time	I_C = - 5 A, I_{B1} = - I_{B2} = - 0.5 A		135		ns
t_{STG}	Storage Time			500		ns
t_F	Fall Time			100		ns

Note:

1. Pulse test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
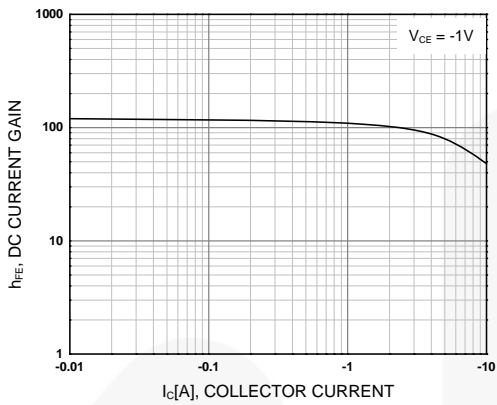
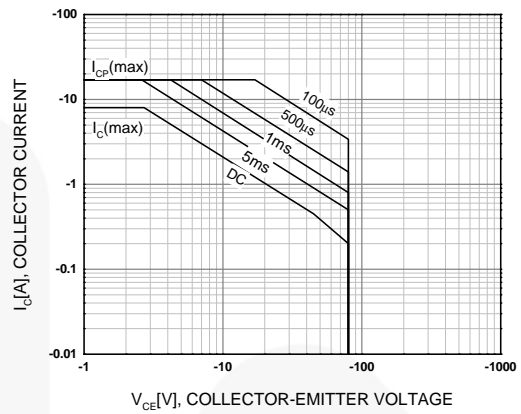## Typical Performance Characteristics

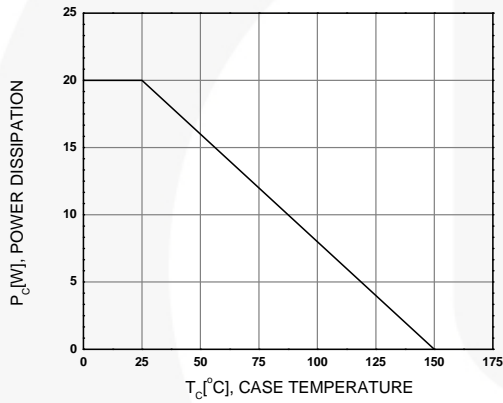
Figure 1. DC Current Gain

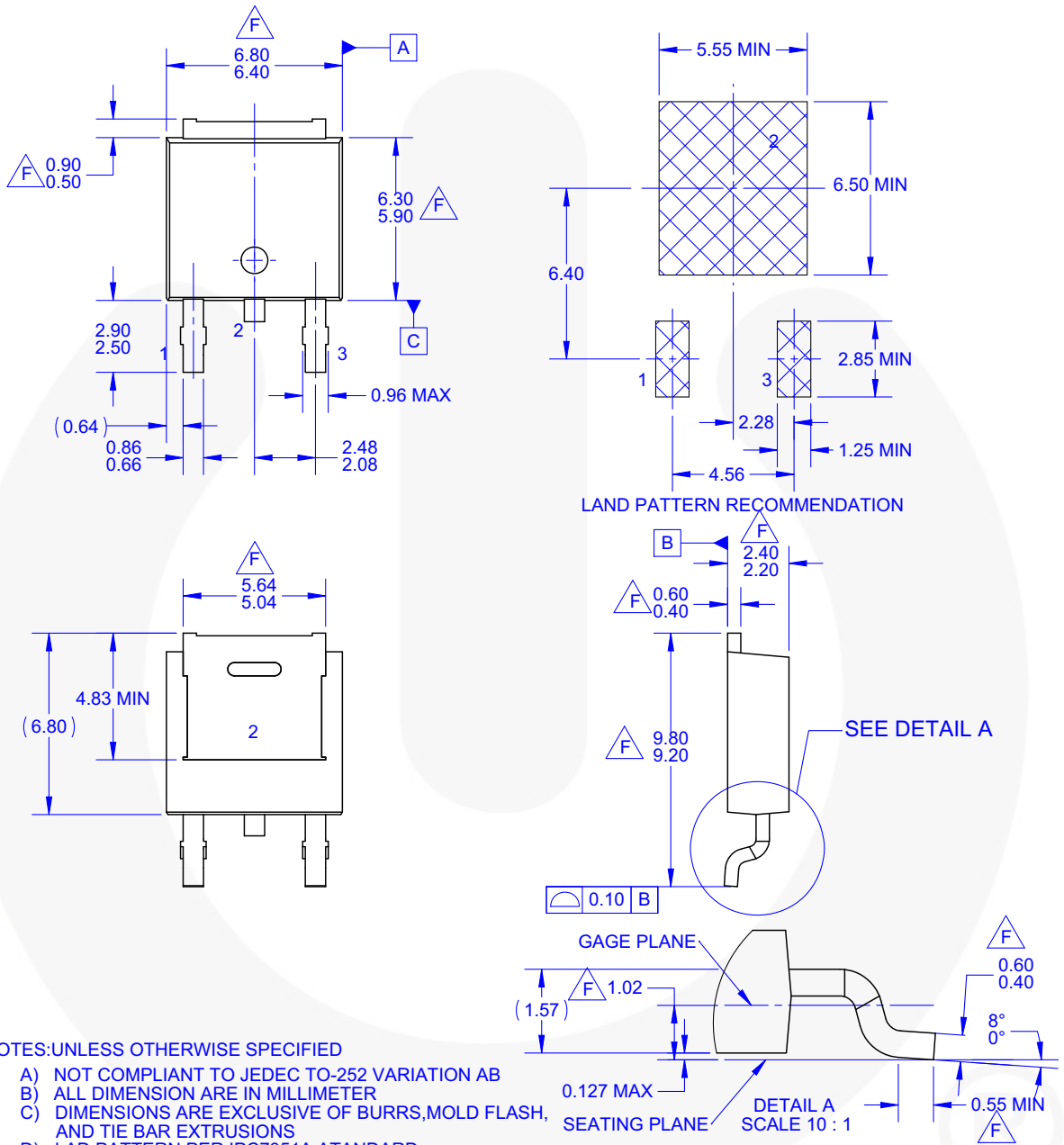Figure 2. Safe Operating Area

Figure 3. Power Derating vs T$_C$
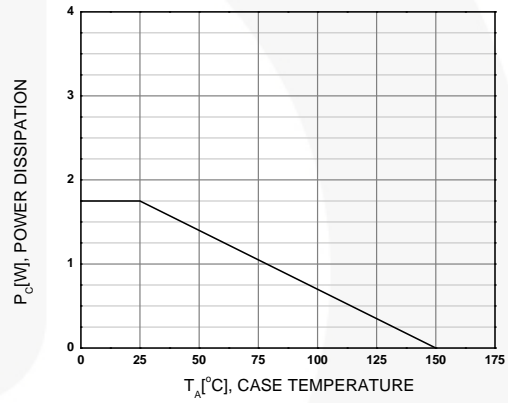
Figure 4. Power Derating vs. T$_A$

Physical Dimensions

5.55 MIN

6.50 MIN

6.40

2.85 MIN

2.28

1.25 MIN

4.56

LAND PATTERN RECOMMENDATION

6.80
6.40

F 0.90
0.50

6.30
5.90 F

2.90
2.50

0.96 MAX

(0.64)

0.86
0.66

2.48
2.08

5.64
5.04

4.83 MIN

(6.80)

B
F 2.40
2.20

F 0.60
0.40

F 9.80
9.20

SEE DETAIL A

⌒ 0.10 B

GAGE PLANE

F 1.02

(1.57)

0.127 MAX

SEATING PLANE

DETAIL A
SCALE 10 : 1

F 0.60
0.40

8°
0°

0.55 MIN

F

NOTES:UNLESS OTHERWISE SPECIFIED

A) NOT COMPLIANT TO JEDEC TO-252 VARIATION AB
B) ALL DIMENSION ARE IN MILLIMETER
C) DIMENSIONS ARE EXCLUSIVE OF BURRS,MOLD FLASH, AND TIE BAR EXTRUSIONS
D) LAD PATTERN PER IPC7351A ATANDARD TO228P991X239-3N
E) DRAWING FILE NAME:MKT-TO252D03REV3.
F) DOES NOT COMPLY JEDEC STANDARD VALUE.
G) FAIRCHILD SEMICONDUCTOR.

Figure 5. 3-LEAD, TO-252, NOT COMPLIANT TO JEDEC TO-252 VAR. AB, SURFACE MOUNT (DPAK)

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Rev. I74

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